

SPECIFICATION FOR LCD MODULE

MODULE NO: AFY240320B0-2.8N6NTM-R **REVISION NO: V01**

Customer's Approval:							
	SIGNATURE	DATE					
PREPARED BY (RD ENGINEER)							
CHECKED BY							
APPROVED BY							

Records of Revision

DATE	REF.PAGE PARAGRAPH DRAWING No.	REVISED No.	SUMMARY	REMARK
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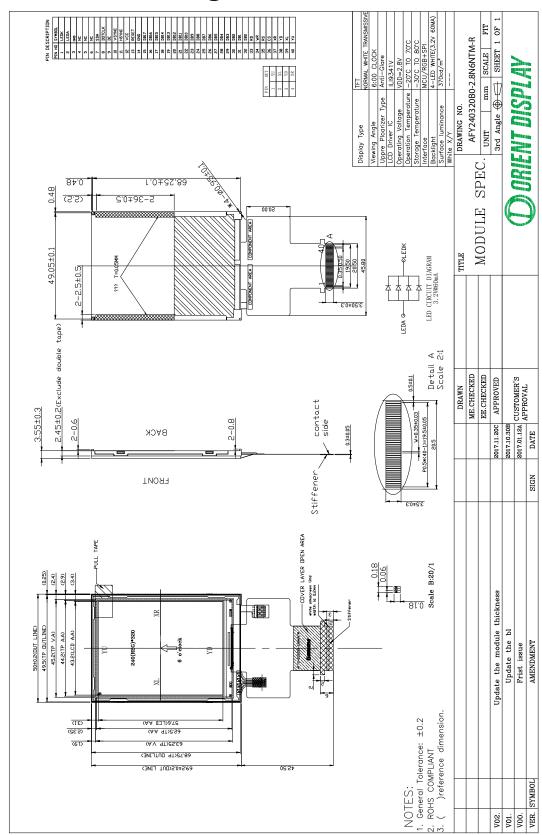
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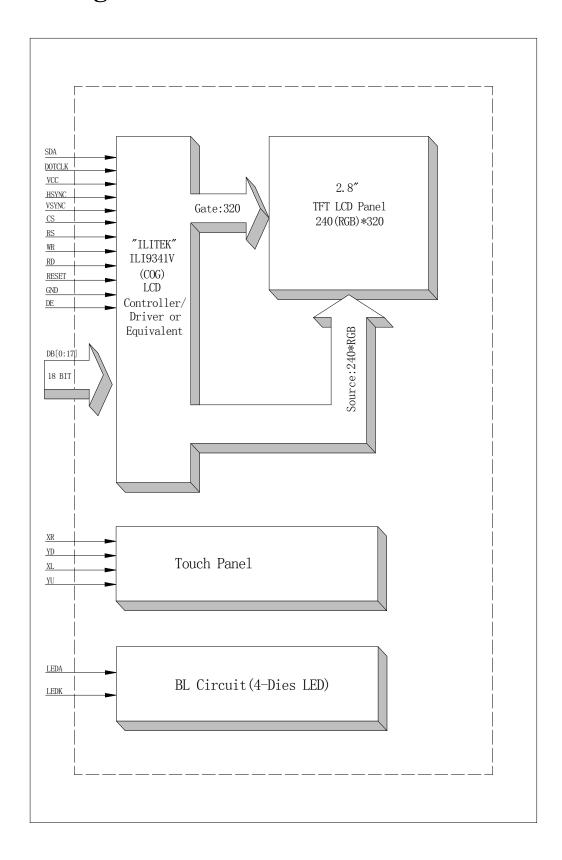
1. General Specification

Item	Contents	Unit
LCD TYPE	TFT/TRANSMISSIVE	
MODULE SIZE (W*H*T)	50.00*69.20*3.55	MM
ACTIVE SIZE (W*H)	43.20*57.60	MM
PIXEL PITCH (W*H)	0.180*0.180	MM
NUMBER OF DOTS	240*320	
DIVER IC	ILI9341V	
INTERFACE TYPE	MCU/RGB+SPI	
TOP POLARIZER TYPE	ANTI-GLARE	
RECOMMEND VIEWING DIRECTION	6	O'CLOCK
GRAY SCALE INVERSION DIRECTION	12	O'CLOCK
BACKLIGHT TYPE	4-DIES WHITE LED	
TOUCH PANEL TYPE	RESISTIVE	

2. Mechanical Drawing



3. Block Diagram



4. Interface Pin Function

Pin No.	Symbol	Description	Remark
1	LEDK	Cathode of LED backlight	
2	LEDA	Anode of LED backlight	
3	GND	Power ground	
4	NC	No connect	
5	NC	No connect	
6	NC	No connect	
7	SDA	Data input pin in serial interface	
8	DOTCLK	Dot-clock signal and oscillator source.	
9	DE	Line Synchronization input	
10	VSYNC	Frame/Ram Write Synchronization input	
11	HSYNC	Line Synchronization input	
12	VCC	Power supply	
13	RESET	Reset pin	
14	GND	Power ground	
15~32	DB17~DB00	Data bus	
33	RD	Read data signal	
34	WR	Write data signal	
35	RS	Data or command select	
36	CS	Chip select input pin ("Low" enable).	
37	XR	TP pin.	
38	YD	TP pin.	
39	XL	TP pin.	
40	YU	TP pin.	

5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply voltage for analog	VCC	-0.3	4.6	V
Supply voltage for logic	VCC	-0.3	4.6	V
Supply current (One LED)	I _{LED}		30	mA
Operating temperature	Тор	-20	+70	°C
Storage temperature	T_{ST}	-30	+80	°C

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

6. Electrical Characteristics

6.1 Input Power

Item	Symbol	Min	Typ.	Max	Unit	Applicable terminal
Supply Voltage for Analog	VCC	2.5	2.8	3.3	V	
Supply Voltage for Logic	VCC	1.65	1.8/2.8	3.3	V	
Input Voltage	$V_{\rm IL}$	GND	-	0.3VCC	V	
Input Voltage	V_{IH}	0.8 VCC	-	VCC	V	
Input leakage Current	I_{LKG}	-1		1	μΑ	

6.2 Backlight Driving Conditions

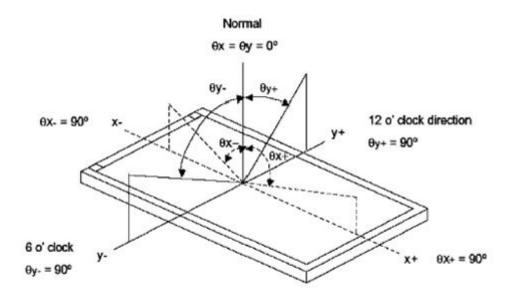
Itom	Symbol		Value	Unit	Remar		
Item	Symbol	Min.	Тур.	Max.	Unit	k	
Voltage for LED Backlight	V _F	2.8	3.2	3.4	V	I _L =60mA	
Current for LED Backlight	IL		60	-	mA		
Power Consumption	P		0.192		W		
LED Life Time		30,000			Hr	Note	

Note: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25 $^{\circ}$ C

7. Optical Characteristics

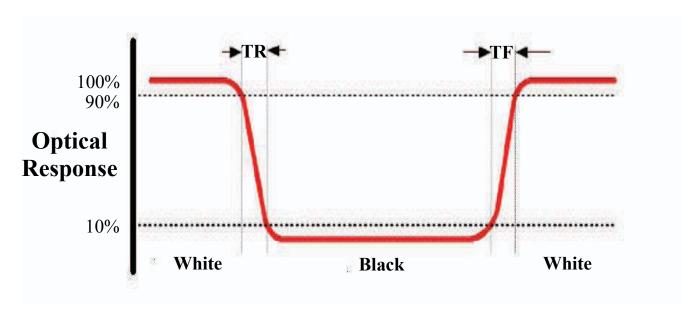
	Л	CVADOI	CONDITIONS	SPEC	IFICAT	ΓΙΟΝS	TINITE	NOTE
ITEM		SYMBOL CONDITION		MIN	TYP.	MAX	UNIT	NOTE
Lumina	nce	L	I _L =60mA	290	370	450	Cd/m ²	
Contrast l	Ratio	CR	θ=0°	400	500			
Dagnanga	Time	Ton	25℃		25	30	122 G	
Response	Time	Тоғғ	23 C		23	30	ms	
	Red	XR						
	Red	YR						
	Green	XG						
CIE Color		YG	Viewing normal					
Coordinate	Blue	Хв	angle					
		YB						
	White	Xw		0.290	0.310	0.330		
	winte	Yw		0.340	0.360	0.380		
	Hor.	θ_{X+}		60	70			
Viewing	пот.	$oldsymbol{ heta}_{X-}$	CR≥10	60	70		5	
Angle	Ver.	$ heta_{\scriptscriptstyle Y+}$	CK=10	60	70		Degree	
	V C1.	$ heta_{\scriptscriptstyle Y-}$		50	60			
Uniformity	Un			80			%	

Note 1: Definition of Viewing Angle θx and θy :



Note 2: Definition of contrast ratio CR:

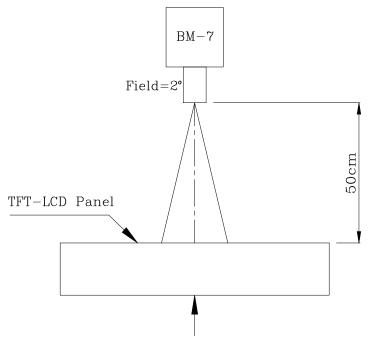
Note 3: Definition of Response Time(Tr,Tf)



Note 4: Definition of Luminance

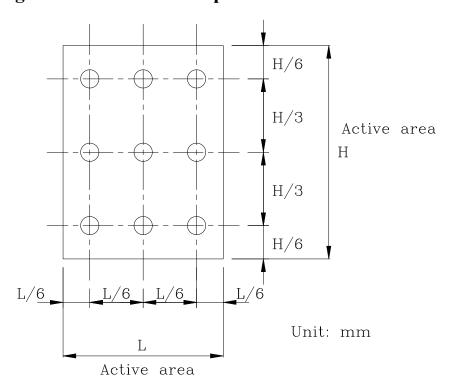
1 The Brightness Test Equipment Setup

Field=2° (As measuring "black" image, field=2° is the best testing condition)



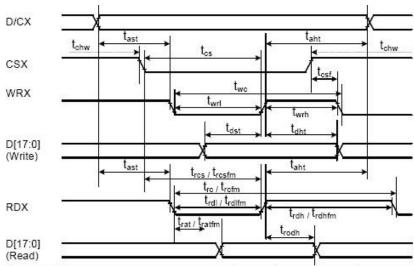
The center of the screen

2 The Brightness Test Point Setup



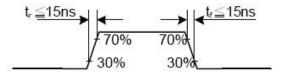
8. Timing Characteristics

8.1 MPU interface characteristic

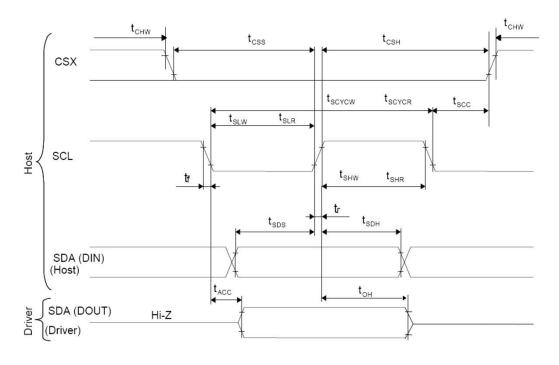


Signal	Symbo	Parameter	min	max	Unit	Description	
Day	tast	Address setup time	0	- 170	ns		
DCX	taht	Address hold time (Write/Read)	0		ns		
× ×	tchw	CSX "H" pulse width	0	-	ns		
	tcs	Chip Select setup time (Write)	15		ns		
CSX	trcs	Chip Select setup time (Read ID)	45	-	ns		
Î	trcsfm	Chip Select setup time (Read FM)	355	141	ns		
	tcsf	Chip Select Wait time (Write/Read)	10	- 2	ns		
į.	twc	Write cycle	66	357	ns		
WRX	twrh	Write Control pulse H duration	15	- 177	ns		
	twrl	Write Control pulse L duration	15		ns		
×	trcfm	Read Cycle (FM)	450	-	ns		
RDX (FM)	trdhfm	Read Control H duration (FM)	90		ns		
92 30 0	trdlfm	Read Control L duration (FM)	355	-	ns		
	trc	Read cycle (ID)	160	141	ns		
RDX (ID)	trdh	Read Control pulse H duration	90	2	ns		
1-04040500000000000000000000000000000000	trdl	Read Control pulse L duration	45	857	ns		
D147.01	tdst	Write data setup time	10	977	ns		
D[17:0],	tdht	Write data hold time	10		ns	For maximum 01 -30-5	
D[17:10]&D[8:1],	trat	Read access time		40	ns	For maximum CL=30pF	
D[17:10],	tratfm	Read access time	1	340	ns	For minimum CL=8pF	
D[17:9]	trod	Read output disable time	20	80	ns		

Note: Ta = -30 to 70 °C, VDDI = 1.65V to 3.3V, VCI = 2.5V to 3.3V, VSS = 0V.

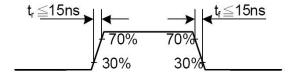


8.2 Serial interface timing characteristic(3-line SPI system)

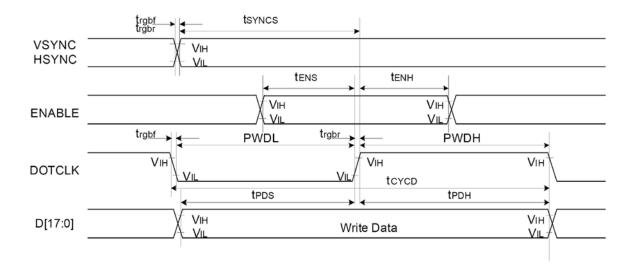


Signal	Symbol	Parameter	min	max	Unit	Description
	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
001	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
SCL	tscycr	Serial Clock Cycle (Read)	150	140	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI	tsds	Data setup time (Write)	30	-	ns	
(Input)	tsdh	Data hold time (Write)	30	3	ns	
SDA / SDO	tacc	Access time (Read)	10	-	ns	
(Output)	toh	Output disable time (Read)	10	50	ns	
	tscc	SCL-CSX	20	-	ns	
CCV	tchw	CSX "H" Pulse Width	40	1940	ns	
CSX	tcss	CSX-SCL Time	60		ns	
	tcsh	CSX-SCL TIME	65	-	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V

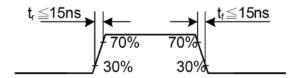


8.3 Parallel RGB interface timing characteristic



Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	í	ns	
HSYNC	t _{SYNCH}	VSYNC/HSYNC hold time	15	ī	ns	
DE	t _{ENS}	DE setup time	15	ī	ns	
DE	t _{ENH}	DE hold time	15	-	ns	
D(17:01	t _{POS}	Data setup time	15	-	ns	18/16-bit bus RGB
D[17:0]	t _{PDH}	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level period	15	-	ns	
DOTCLK	PWDL	DOTCLK low-level period	15	-	ns	
DOTCLK	t _{CYCD}	DOTCLK cycle time	100	-	ns	
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	-	ns	
DE	t _{ENS}	DE setup time	15	-	ns	
DE	t _{ENH}	DE hold time	15	-	ns	
D(47.01	t _{POS}	Data setup time	15	-	ns	6-bit bus RGB
D[17:0]	t _{PDH}	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level pulse period	15	-	ns	
DOTCLK	PWDL	DOTCLK low-level pulse period	15	-	ns	
DOTCLK	tcycd	DOTCLK cycle time	50	-	ns	
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V



9. Standard Specification for Reliability

9.1 Standard Specification for Reliability of LCD Module

No.	Item	Description	Remarks
110.	Ittili		IXCIII ai K5
01	High temperature operation	The sample should be allowed to stand at 70°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.	Note 1 IEC60068-2-2, GB2423.2-89
02	Low temperature operation	The sample should be allowed to stand at -20°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.	Note2 IEC60068-2-1 GB2423.1-89
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.	IEC60068-2-2 GB2423.2-89
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.	IEC60068-2-1 GB/T2423.1-89
05	Moisture storage	The sample should be allowed to stand at $60^{\circ}\text{C},90\%\text{RH}$ MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.	IEC60068-2-1 GB/T2423.3-2006
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles: -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.	Start with cold temperature,end with high temperature IEC60068-2-14, GB2423.22-87
07	Packing vibration	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.	IEC61000-2-6 GB/T2423.5-1995
08	Packing drop test	According to ASTM-D-5327.	IEC60068-2-32 GB/T2423.8-1995
09	Electrical Static	Air: ±4KV 150pF/330Ω 5 times	IEC61000-4-2
UY	Discharge	Contact: ±2KV 150pF/330Ω 5 time	GB/T17626.2-1998

Note:1.Ts is the temperature of panel's surface.

^{2.} Ta is the ambient temperature of sample.

^{3.} Sample size for each test item is 3~5pcs.

9.2 Testing Conditions and Inspection Criteria

For the final test, the testing sample must be stored at room temperature for 24 hours. After the tests listed in Table 9.2, standard specifications for reliability will be executed in order to ensure stability.

No.	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9.3 MTBF

Functions, performance, appearance, etc. shall be free from remarkab deterioration within 50,000 hours under ordinary operating and storage condition room temperature (25±5°C), normal humidity (50±10% RH), and in area nexposed to direct sun light.	ons
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10. Specification of Quality Assurance

This standard of Quality Assurance confirms to the quality of LCD module products supplied by ODNA.

10.1 Quality Test

Before delivering, the supplier should conduct the following tests to confirm the quality of products.

- Electrical-Optical Characteristics: According to the individual specification to test the product.
- Appearance Characteristics: According to the individual specification to test the product.
- Reliability Characteristics: According to the definition of reliability on the specification for testing products.

10.2 Delivery Test

Before delivering, the supplier should conduct the delivery test.

- Test method: According to MIL-STD105E.General Inspection Level II take a single Time.
- The defects classify of AQL as following:

Major defect: AQL = 0.65 Minor defect: AQL = 2.5 Total defects: AQL = 2.5

10.3 Non-conforming Analysis & Deal With Manners

10.3.1 Non-conforming Analysis

- Purchaser should provide the data detail of non-conforming sample and the non-conforming.
- After receiving the data detail from purchaser, the analysis of non-conforming should be finished within two weeks.
- If the analysis can't be finished on time, supplier must notice purchaser 3 days in advance.

10.3.2 Disposition of non-conforming

- If any product defect be found during assembling, supplier must change the good for every defect after confirmation.
- Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

10.4 Agreement items

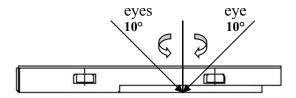
Both parties should negotiate together when the following problems happen.

- There is any problem of standard of quality assurance, and both sides should agree that it must be modified.
- There is any argument item which does not record in the standard of quality assurance.
- Any other special problem.

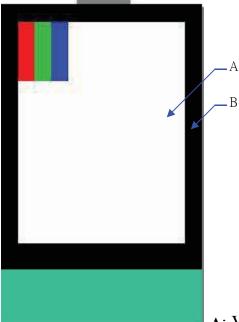
10.5 Standard of The Product Appearance Test

10.5.1 Manner of appearance test

- The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- When test the model of transmissive product must add the reflective plate.
- The test direction is base on around 10° of vertical line.
- Temperature: 25±5 °C Humidity: 60±10%RH



• Definition of area:



A: Viewing area B: Outside viewing area

10.5.2 Basic principle

- When the standard can not be described, AQL will be applied.
- The sample of the lowest acceptable quality level must be negotiated by both supplier and customer when any dispute happened.
- New item must be added on time when it is necessary.

10.6 Inspection Specification

NO.	Item	Criterion				
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker 			0.65	
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	 2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm. 			2.5	
	LCD and Touch Panel black	3.1 Round type: As follows: $\Phi = (X+Y)/2$ * Densely spaced: No		Size(mm) $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi \le 0.30$ $0.30 < \Phi$	Acceptable Q'ty Accept no dense 2 2 1 0 spots within 3mm.	2.5
03	spots, white spots, contaminati on (non – display)	3.2 Line type: (As follows)	Length(mm) L≤3.0 L≤2.5	mg) Width(mm) $W \le 0.02$ $0.02 < W \le 0.05$ $0.03 < W \le 0.08$ $0.08 < W$	Acceptable Q'ty Accept no dense 2 Rejection o lines within 3mm.	2.5

NO.	Item	Criterion			
	Polarizer	If bubbles are visible, judge using black spot specifications, not easy	Size $\Phi(mm)$ $\Phi \leq 0.20$	Acceptable Q'ty Accept no dense	
04	bubbles	to find, must check in	$0.20 < \Phi \le 0.50$	3	2.5
		specify direction	0.50< Φ ≤ 1.00	2	
			1.00< Ф	0	
			Total Q'ty	3	
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass	x: Chip length y: Chip width z: k: Seal width t: Glass thickness L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack z: Chip thickness y: Chip width Z ≤ 1/2t Not over view area 1/2t< z ≤ 2t Not exceed Unit: mm If there are 2 or more chips, x is the foliation of the context of the	x: Chip lengwing $x \le 1/8a$	chip	2.5

NO.	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function , we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle.13.2 No short circuits in components on PCB or FPC.	2.5 0.65

NO.	Item	Criterion	AQL
	Symbols: x: Chip length y: Chip width k: Seal width t: Glass thicknot L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:	x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal:	
		y: Chip width x: Chip length z: Chip thickness	
		$y \le 0.5 \text{mm}$ $x \le 1/8 a$ $0 < z \le t$	
		7.2.2 Non-conductive portion:	
07	Glass crack	y z z z z z z z z z z z z z z z z z z z	2.5
		y: Chip width x: Chip length z: Chip thickness	
		$y \le L \qquad x \le 1/8a \qquad 0 < z \le t$	
	must remain and be inspected according to electrode tesspecifications.	• If the product will be heat sealed by the customer, the alignment mark must mot be damaged.	
		y: width x: length	
		$y \le 1/3L \qquad X \le a$	

NO.	Item		Criterion		AQL
14	Touch Panel Chipped glass	k: Seal width t: 'L: Electrode pad leng 14.1 General glass cl 14.1.1 Chip on panel z: Chip thickness Z≦t O Unit: mm	gth hip: I surface and crack between two surface and crack between two surfaces and crack be	x: Chip length $x \le 1/8a$	2.5
		z: Chip thickness	y: Chip width	x: Chip length	
		z≦t	≤ 1/2 k and not over viewing area	x ≤ 1/8a	
		⊙ Unit: mm⊙ If there are 2 or m	nore chips, x is the total	length of each chip	

NO.	Item	Criterion		
15	Touch Panel(Fish eye dent and bubble on film)	$\begin{array}{ c c c }\hline SIZE(mm) & Acceptable Q'ty\\\hline \Phi \leq 0.2 & Accept no dense\\\hline 0.2 < D \leq 0.4 & 5\\\hline 0.4 < D \leq 0.5 & 2\\\hline 0.5 < D & 0\\\hline \end{array}$	2.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.	2.5	
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5	
19	General appearance	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 		

11. Handling Precaution

11.1 Handling of LCM

- Avoid external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance, do not lick or swallow. When the liquid is attaching to your hand, skin, cloth, etc., wash it thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should wear protections whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface, be careful when peeling off this protective film since static electricity may be generated.

11.2 Storage

- Store it in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Store it in a clean environment, free from dust, active gas, and solvent.
- Store it in anti-static electricity container.
- Store it without any physical load.

11.3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: no higher than 280±10°C and less than 3 sec during hand soldering.
- Rewiring: no more than 2 times.

12. Packing Method

----TBD